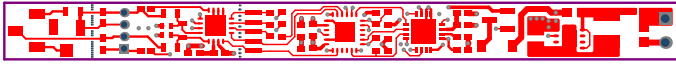




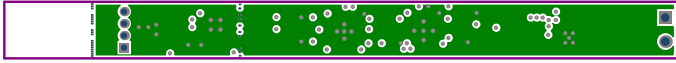
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 5/6/2014	11:51:11 AM	TEXAS INSTRUMENTS



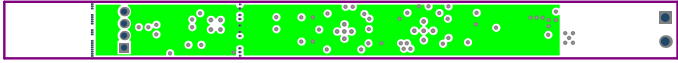
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 5/6/2014 11:51:11 AM	TEXAS INSTRUMENTS	



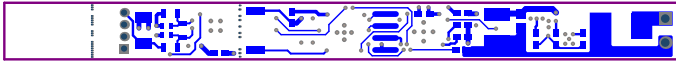
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 5/6/2014 11:51:12 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer2_GND Plane			
PLOT NAME = P1_GNDPLANE	GENERATED : 5/6/2014	11:51:12 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer3_UCC Plane			
PLOT NAME = P2_PWRPLANE	GENERATED : 5/6/2014	11:51:12 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 5/6/2014 11:51:12 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 5/6/2014 11:51:12 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 5/6/2014 11:51:12 AM	TEXAS INSTRUMENTS	

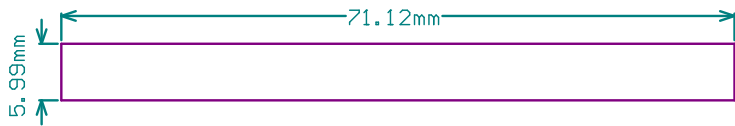


Symbol	Hit Count	Tool Size	Plated	Hole Type
○	21	8mil (0.203mm)	NPTH	Round
□	80	8mil (0.203mm)	PTH	Round
▽	4	25.591mil (0.65mm)	PTH	Round
☆	2	35.039mil (0.89mm)	PTH	Round
	107 Total			

DRILL TOLERANCE  
FOR NPTH +/- 2MIL  
EXCEPT 8MIL DRILL +/- 3MIL  
FOR 8 MIL DRILL +/- 8 MIL



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 5/6/2014	11:51:12 AM	TEXAS INSTRUMENTS



←1000 (mil)→

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00165	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Board Dimensions	GENERATED : 5/6/2014	11:51:12 AM	TEXAS INSTRUMENTS

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